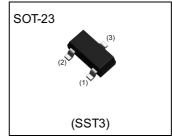


NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value		
V _{CEO}	50V		
I _C	100mA		
R ₁	4.7kΩ		

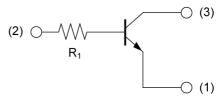
Outline



Features

- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA143TCA

•Inner circuit



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC143TCA	SOT-23 (SST3)	2924	T116	180	8	3000	03

● **Absolute maximum ratings** (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	50	V
Collector-emitter voltage	V _{CEO}	50	V
Emitter-base voltage	V _{EBO}	5	V
Collector current	I _C	100	mA
Device discipation	P _D *1	200	mW
Power dissipation	P _D *2	350	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Darameter	Cumb al	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	BV_{CBO} $I_C = 50\mu A$		-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	EO I _C = 1mA		-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	5	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = 50V	ı	-	500	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 4V	ı	-	500	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 5mA, I_B = 0.25mA$	ı	-	300	mV	
DC current gain	h _{FE}	$V_{CE} = 5V$, $I_{C} = 1mA$	100	250	600	-	
Input resistance	R_1	-	3.29	4.7	6.11	kΩ	
Transition frequency	f _T *3	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

^{*1} Each terminal mounted on a reference land.

^{*2} Mounted on a ceramic board(7.0×5.0×0.6mm).

^{*3} Characteristics of built-in transistor

● Electrical characteristic curves (T_a =25°C)

Fig.1 Grounded emitter propagation characteristics

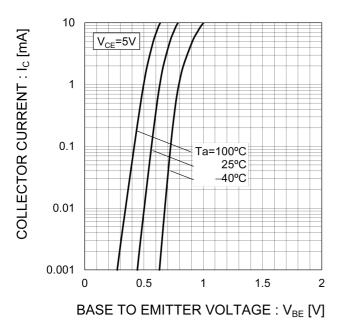


Fig.2 Grounded emitter output characteristics

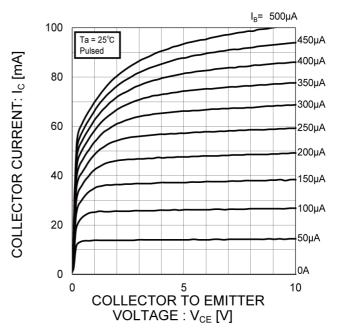


Fig.3 DC Current gain vs. Collector Current

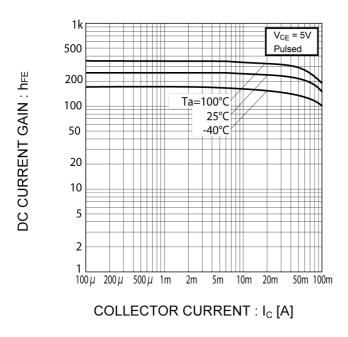
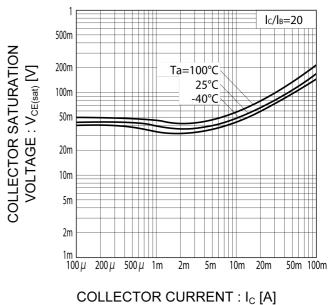
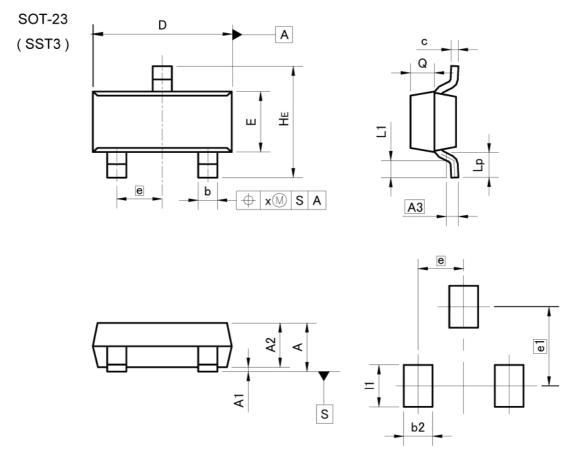


Fig.4 Collector-emitter saturation voltage vs. Collector Current



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.90	1.20	0.035	0.047	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.15	0.033	0.045	
A3	0.3	25	0.0	10	
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.70	3.10	0.106	0.122	
E	1.20	1.50	0.047	0.059	
е	0.95		0.037		
HE	2.20	2.60	0.087	0.102	
L1	0.20	00	0.008	-	
Lp	0.30	p.=.;	0.012	u=-	
Q	0.40	0.60	0.016	0.024	
х	- 2	0.10	-	0.004	

DIM		MILIM	ETERS	INCHES		
DIN	MIN		MAX	MIN	MAX	
b2			0.60	_	0.024	
e1		1.70		0.0	67	
- 11		-3	0.90	-	0.035	

Dimension in mm/inches



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CLASSⅢ	CLACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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